

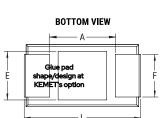
## T489D226K035AHE300

T489, Tantalum, MnO2 Tantalum, Commercial Grade, 22 uF, 10%, 35 VDC, SMD, MnO2, Molded, Low Leakage, 300 mOhms, 7343, 3.1 mm, 1.3 mm

CATHODE (-) END VIEW SIDE VIEW W Н S -----— G – Termination cutout at KEMET's option, either end ANODE (+) END VIEW



P-



- |- s-

Click here for the 3D model.

General Information	
Series	T489
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, Low Leakage
Features	Low Leakage
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov /
SCIP Number	1dd2e1b8-26dd-4d52-927c-6f9 d519011aa
Termination	Tin Lead (SnPb)
AEC-Q200	No
Typical Component Weight	446.84 mg
Shelf Life	156 Weeks
MSL	1

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
н	2.8mm +/-0.3mm
т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
А	3.8mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
Ρ	0.9mm REF
R	1mm REF
Х	0.1mm +/-0.1mm REF

#### 22 uF Capacitance Tolerance 10% Voltage DC 35 VDC (85C), 23.45 VDC (125C) -55/+125°C **Temperature Range Rated Temperature** 85°C **Dissipation Factor** 6% 120Hz 25C Failure Rate N/A ESR 300 mOhms (100kHz 25C) **Ripple Current** 707 mA (rms, 100kHz 25C) 5.8 uA (5min 25°C) Leakage Current

# **Packaging Specifications**

Packaging	T&R, 178mm
Packaging Quantity	500

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Specifications

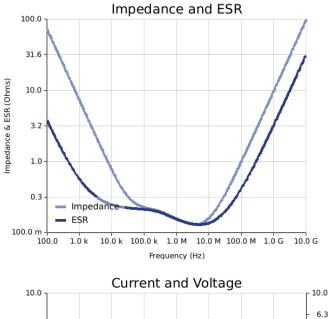


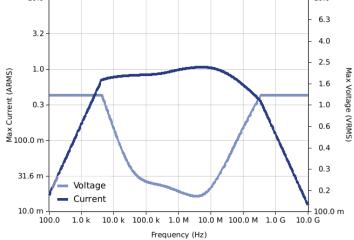
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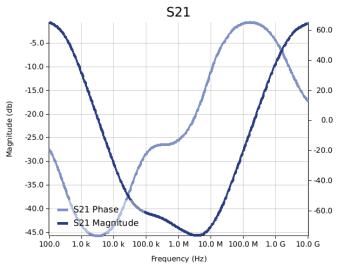
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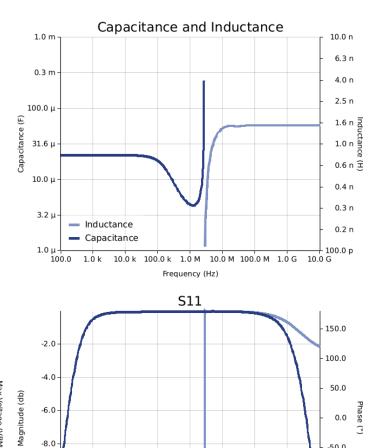
### Simulations

For the complete simulation environment please visit K-SIM.



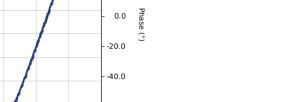






10.0 k 100.0 k 1.0 M 10.0 M 100.0 M 1.0 G

Frequency (Hz)



-8.0

-10.0

-12.0

100.0

S11 Phase

1.0 k

S11 Magnitude

0.0

-50.0

-100.0

-150.0

10.0 G



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#### These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
  The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
  The effects shown herein are based on measured data from a multiple part sample of the parts in question.
  Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages and the part of the parts of the part of the
- generated at any other harmonics.
  Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.